

DUAL SURFACE MOUNT SCHOTTKY BARRIER DIODE
Product Summary

V_R (V)	I_F (A)	V_F Max (V) @ +25°C	I_R Max (μA) @ +25°C
20	0.4	0.43	250

Features and Benefits

- Very Low Forward Voltage Drop
- Guard Ring Construction for Transient Protection
- High Conductance
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **PPAP Capable (Note 4)**

Applications

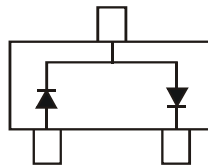
- DC-DC Converters
- Mobile Telecommunications
- Blocking Diodes
- Reverse Polarity Protection

Mechanical Data

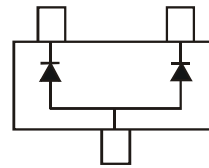
- Case: SOT23
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Lead Free Plating (Matte Tin Finish Annealed over Alloy 42 Leadframe). Solderable per MIL-STD-202, Method 208
- Polarity: See Diagram
- Weight: 0.008 grams (Approximate)



Top View



SDM40E20LSQ

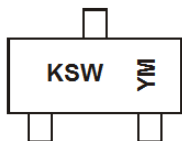


SDM40E20LAQ

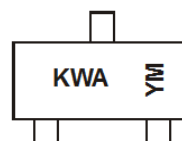
Ordering Information (Note 5)

Part Number	Compliance	Case	Packaging
SDM40E20LSQ-7-F	Automotive	SOT23	3000/Tape & Reel
SDM40E20LAQ-7	Automotive	SOT23	3000/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to <https://www.diodes.com/quality/>.
 5. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information


KSW = SDM40E20LSQ Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: G = 2019)
 M = Month (ex: 9 = September)



KWA = SDM40E20LAQ Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: G = 2019)
 M = Month (ex: 9 = September)

Date Code Key

Year	2015	2016	2017	2018	2019	2020	2021	2022	2023	2024	2025
Code	C	D	E	F	G	H	I	J	K	L	M

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	20	V
Working Peak Reverse Voltage	V _{RWM}		
DC Blocking Voltage	V _R		
RMS Reverse Voltage	V _{R(RMS)}	14	V
Forward Continuous Current (Note 6)	I _F	0.4	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	2	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6) (Note 7)	P _D	225	mW
		300	
Typical Thermal Resistance Junction to Ambient (Note 6) (Note 7)	R _{θJA}	444	°C/W
		333	
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +125	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Conditions
Reverse Breakdown Voltage (Note 8)	V _{(BR)R}	20	—	—	V	I _R = 0.5mA
Forward Voltage Drop	V _F	—	—	0.310	V	I _F = 0.1A
		—	—	0.430		I _F = 0.5A
Leakage Current (Note 8)	I _R	—	—	100	μA	V _R = 10V
		—	—	250		V _R = 20V
Total Capacitance	C _T	—	120	—	pF	f = 1MHz, V _R = 0V _{DC}

- Notes:
6. Device mounted on FR-5 1.0 x 0.75 x 0.062 inch PCB pad layout.
 7. Device mounted on Alumina PCB, 0.4 inch x 0.3 inch x 0.024 inch pad layout.
 8. Short duration pulse test used to minimize self-heating effect.

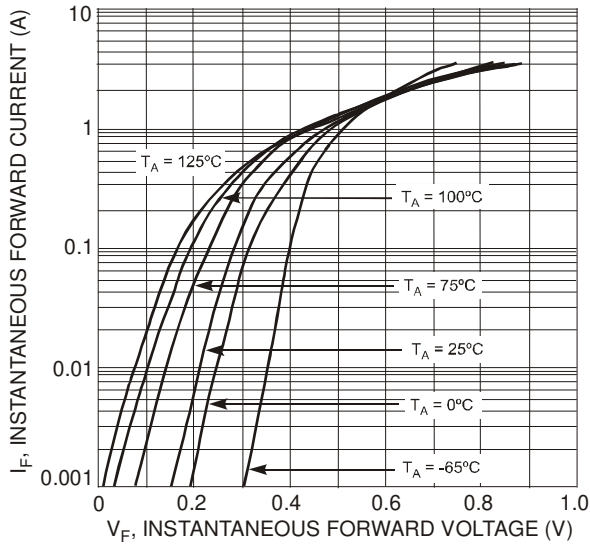


Fig. 1 Typical Forward Characteristics, Per Element

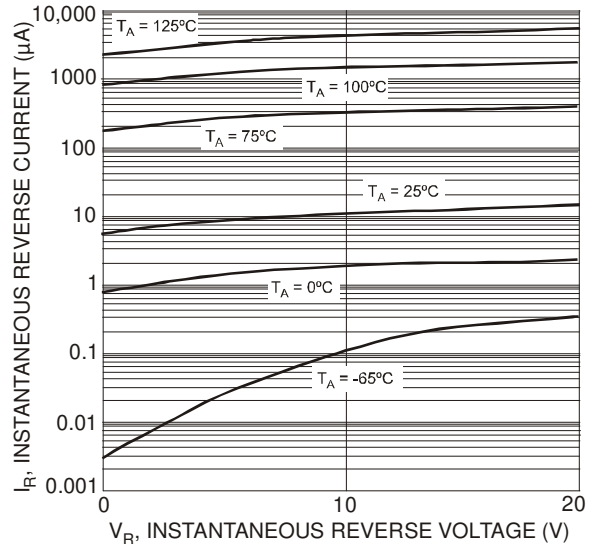


Fig. 2 Typical Reverse Characteristics, Per Element

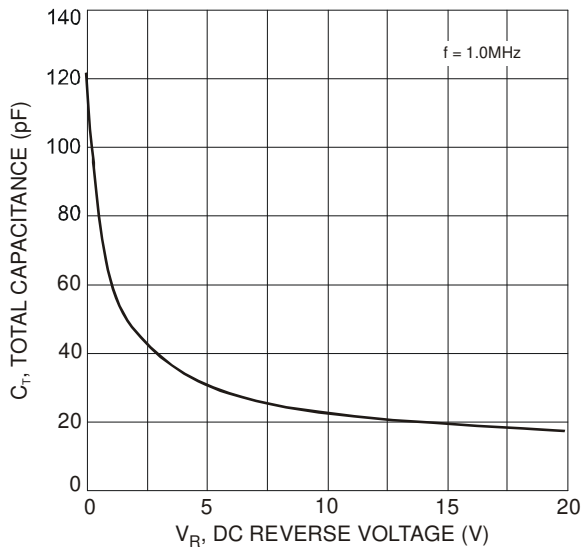


Fig. 3 Total Capacitance vs. Reverse Voltage, Per Element

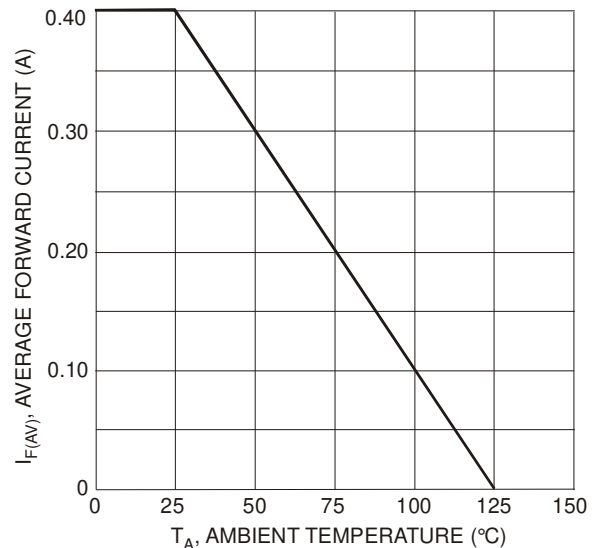
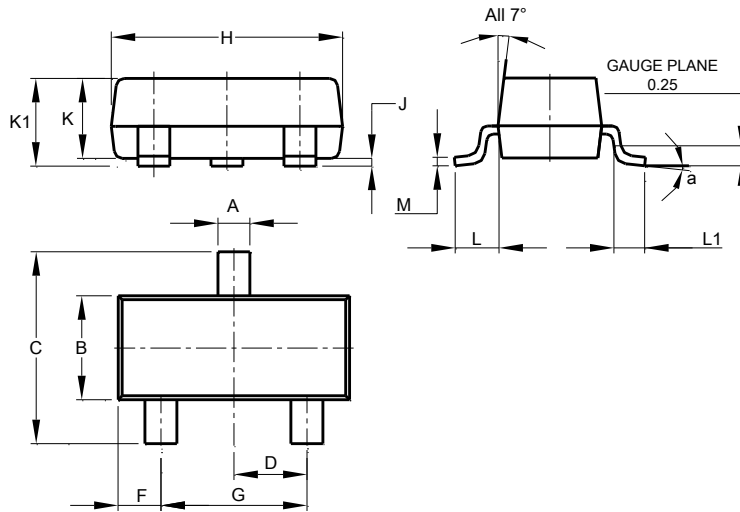


Fig. 4 Forward Current Derating Curve, Per Element

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT23

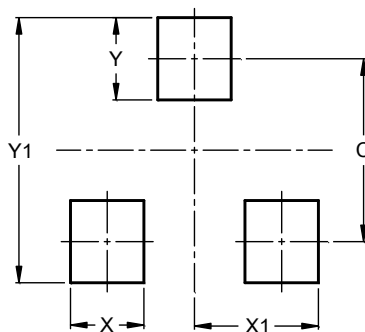


SOT23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
M	0.085	0.150	0.110
a	0°	8°	--
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT23



Dimensions	Value (in mm)
C	2.0
X	0.8
X1	1.35
Y	0.9
Y1	2.9

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